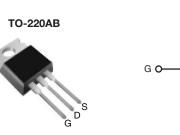


Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	400				
R _{DS(on)} (Ω)	V _{GS} = 10 V 1.0				
Q _g (Max.) (nC)	38				
Q _{gs} (nC)	5.7				
Q _{gd} (nC)	22				
Configuration	Single				



S N-Channel MOSFET

FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- · Fast Switching
- · Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION			
Package	TO-220AB		
Lead (Pb)-free	IRF730PbF		
	SiHF730-E3		
SnPb	IRF730		
	SiHF730		

ABSOLUTE MAXIMUM RATINGS ($T_{\rm C}$	– 25 O, um					
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	400	v	
Gate-Source Voltage			V _{GS}	± 20	V	
Continuous Drain Current	$T_{\rm C} = 25 ^{\circ}{\rm C}$		1	5.5		
Continuous Drain Current	V _{GS} at 10 V	T _C = 100 °C	I _D	3.5	А	
Pulsed Drain Current ^a			I _{DM}	22		
Linear Derating Factor				0.59	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	290	mJ	
Repetitive Avalanche Current ^a			I _{AR}	5.5	A	
Repetitive Avalanche Energy ^a			E _{AR}	7.4	mJ	
Maximum Power Dissipation	T _C =	25 °C	P _D	74	W	
Peak Diode Recovery dV/dt ^c			dV/dt	4.0	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	•••	
Soldering Recommendations (Peak Temperature)	for 10 s			300 ^d	°C	
Mounting Torque	6-32 or M3 screw			10	lbf ∙ in	
Mounting Torque				1.1	N · m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

k. V_{DD} = 50 V, starting T_J = 25 °C, L = 16 mH, R_g = 25 Ω , I_{AS} = 5.5 A (see fig. 12). c. I_{SD} \leq 5.5 A, dI/dt \leq 90 A/µs, V_{DD} \leq V_{DS}, T_J \leq 150 °C. d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-		62				
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50 -			°C/W			
Maximum Junction-to-Case (Drain)	R _{thJC}	-	- 1.7					
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$, u	Inless otherw	ise noted)						
PARAMETER	SYMBOL	TEST	CONDITI	ONS	MIN.	TYP.	MAX.	UNIT
Static							•	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0	0 V, I _D = 2	50 µA	400	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C,	l _D = 1 mA	-	0.54	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} = V	/ _{GS} , I _D = 2	50 µA	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}	Vo	GS = ± 20 \	/	-	-	± 100	nA
7		$V_{DS} = 4$	100 V, V _{GS}	= 0 V	-	-	25	
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 320 V,	V _{GS} = 0 V,	T _J = 125 °C	-	-	250	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D	= 3.3 A ^b	-	-	1.0	Ω
Forward Transconductance	9 _{fs}	V _{DS} = 5	50 V, I _D = 3	3.3 A ^b	2.9	-	-	S
Dynamic		•						
Input Capacitance	C _{iss}	N 01/			-	700	-	pF
Output Capacitance	C _{oss}	$V_{GS} = 0 V, V_{DS} = 25 V, f = 1.0 MHz, see fig. 5$		-	170	-		
Reverse Transfer Capacitance	C _{rss}			-	64	-		
Total Gate Charge	Qg	$V_{GS} = 10 \text{ V}$ $I_D = 3.5 \text{ A}, V_{DS} = 320 \text{ V},$ see fig. 6 and 13 ^b		-	-	38	nC	
Gate-Source Charge	Q _{gs}			-	-	5.7		
Gate-Drain Charge	Q _{gd}		see fig. 6 and 13°		-	-	22	1
Turn-On Delay Time	t _{d(on)}		1		-	10	-	
Rise Time	t _r	Voo = 2	200 V. In =	3.5 A	-	15	-	
Turn-Off Delay Time	t _{d(off)}	V _{DD} = 200 V, I _D = 3.5 A - 15				-	ns	
Fall Time	t _f				-	14	-	
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact - 4.5 - 4.5 - 7.5 -		-				
Internal Source Inductance	L _S			7.5	-	nH nH		
Drain-Source Body Diode Characteristic	cs							
Continuous Source-Drain Diode Current	١ _S	showing the		5.5	- A			
Pulsed Diode Forward Current ^a	I _{SM}	p - n junction diode			-	-	22	
Body Diode Voltage	V_{SD}	T _J = 25 °C, I	_S = 5.5 A,	$V_{GS} = 0 V^{b}$	-	-	1.6	V
Body Diode Reverse Recovery Time	t _{rr}	T _J = 25 °C, I _F =	354 dl/		-	270	530	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$I_{\rm J} = 23$ O, $I_{\rm F} =$	0.0 A, ul/0	μι – 100 Αγμδ ^ο	-	1.8	2.2	μC
Forward Turn-On Time	t _{on}	Intrinsic turr	n-on time i	s negligible (turn	-on is dor	ninated b	$v L_s and$	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

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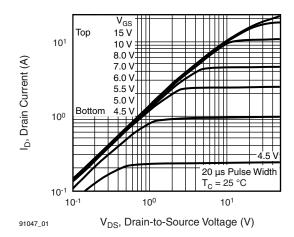


Fig. 1 - Typical Output Characteristics, $T_C = 25 \ ^{\circ}C$

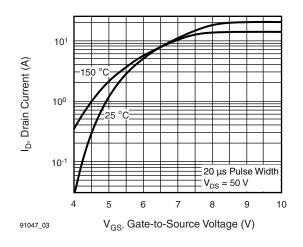


Fig. 3 - Typical Transfer Characteristics

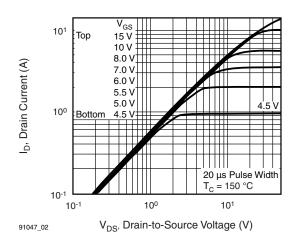


Fig. 2 - Typical Output Characteristics, $T_C = 150 \ ^{\circ}C$

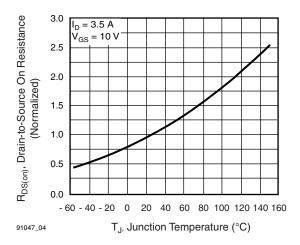


Fig. 4 - Normalized On-Resistance vs. Temperature

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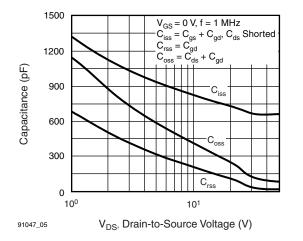
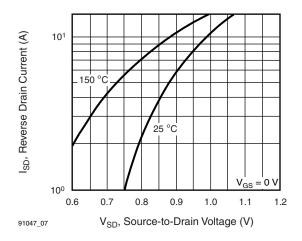
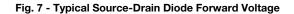


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





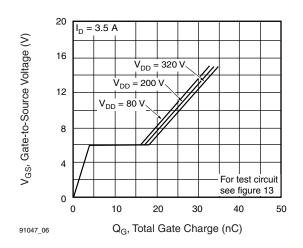


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

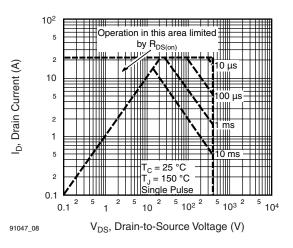


Fig. 8 - Maximum Safe Operating Area

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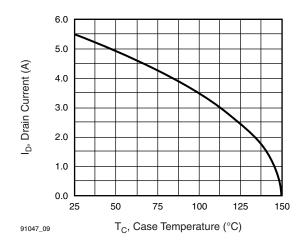


Fig. 9 - Maximum Drain Current vs. Case Temperature

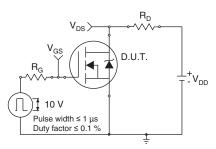


Fig. 10a - Switching Time Test Circuit

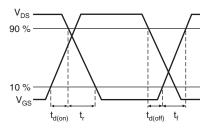


Fig. 10b - Switching Time Waveforms

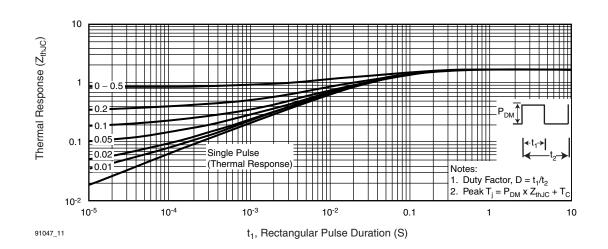


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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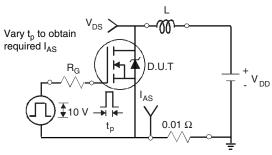


Fig. 12a - Unclamped Inductive Test Circuit

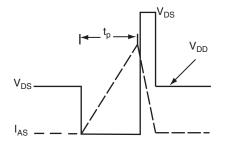
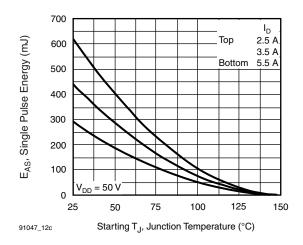
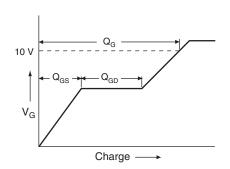


Fig. 12b - Unclamped Inductive Waveforms









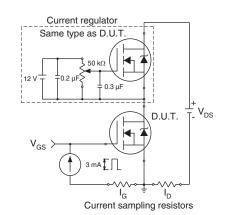
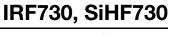


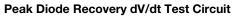
Fig. 13b - Gate Charge Test Circuit

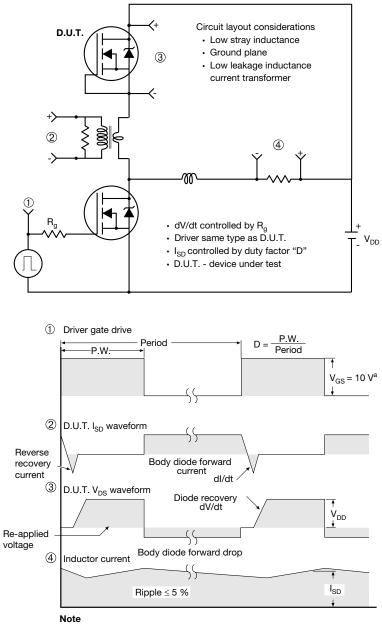
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a. $V_{GS} = 5 V$ for logic level devices

Fig. 14 - For N-Channel

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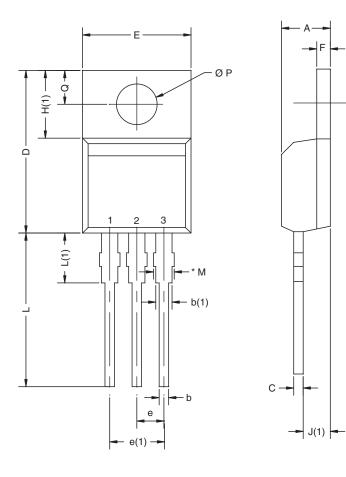
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Package Information

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TO-220AB



	MILLIMETERS		INC	CHES	
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
E	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØΡ	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	
	0416-Rev. M,		0.102	0.11	

Note

 * M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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